## **SPECIFICATIONS**

# ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Symbol	Parameter	Conditions	Ratings	Unit
I <sub>CC</sub> max Maximum Input Current t		t ≤ 20 ms	200	mA
V <sub>OUT</sub> max	Maximum Applied Output Voltage		Internal	V
I <sub>OUT</sub> max	Maximum Output Current		1.0	Α
I <sub>RD</sub> max	Current Flowing into RD, FG		10	mA
V <sub>RD</sub> max	RD, FG Applied Voltage		30	V
V <sub>ST</sub> max ST Applied Voltage			7.5	V
P <sub>d</sub> max	Allowable Power Dissipation	Mounted on a specified board (Note 1)	800	mW
T <sub>opr</sub>	Operating Temperature		-30 to +80	°C
T <sub>stg</sub>	Storage Temperature		-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

# ALLOWABLE OPERATING RANGES $(T_A = 25^{\circ}C)$

Symbol	Parameter	Conditions	Ratings	Unit
I <sub>CC</sub>	I <sub>CC</sub> Input Current Range		6.0 to 50	mA
V <sub>ICM</sub>	Common Mode Input Voltage Range		0.2 to V <sub>IN</sub> -1.5	V
V <sub>ST</sub> H	ST High Voltage		4.5 to 7.0	V
V <sub>ST</sub> L	ST Low Voltage		0 to 0.5	V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25$ °C, $I_{CC} = 10$ mA)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>O</sub> LM1	Output Limiter Withstand Voltage	Z1, Z2 open	54	57	60	V
V <sub>O</sub> LM2	7	Z1, Z2 short	31	33	35	V
V <sub>O</sub> sat1	Output Saturation Voltage	I <sub>O</sub> = 0.5 A	-	0.95	1.2	V
V <sub>O</sub> sat2	7	I <sub>O</sub> = 1.0 A	-	1.15	1.5	V
V <sub>IN</sub>	V <sub>IN</sub> Voltage	I <sub>CC</sub> = 7.0 mA	6.4	6.7	7.0	V
$V_{HN}$	Hall Input Sensitivity (at Zero Peak)	Including offset and hysteresis	-	-	20	mV
V <sub>RD</sub> sat	RD, FG Output Saturation Voltage	I <sub>RD</sub> = 5 mA	-	0.1	0.3	V
IC1	IC1 CT Drain Current IC2 CT Discharge Current	C = GND	2.7	3.8	4.9	μΑ
IC2		C = V <sub>IN</sub>	0.19	0.30	0.41	μΑ
V <sub>TH</sub> 1	Comp Input Threshold Voltage		0.77	0.8V <sub>IN</sub>	0.83	V
V <sub>TH</sub> 2	7		0.42	0.45V <sub>IN</sub>	0.48	V
I <sub>ST</sub>	ST Input Current	V <sub>ST</sub> = 5 V	-	80	120	μΑ
TSD	Thermal Protection Operating Temperature	Design target value (Note 2)	-	180	-	°C
ΔTSD	Thermal Protection Circuit Hysteresis	Design target value (Note 2)	-	40	-	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

<sup>1. .</sup>Specified board: 20 mm × 15 mm × 1.5 mm, glass epoxy board.

# 2. Design target value, Do not measurement.

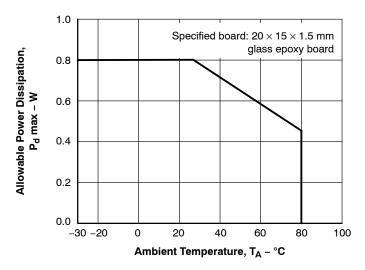


Figure 1. P<sub>d</sub> max – T<sub>A</sub>

# **PIN FUNCTION**

Pin No.	Pin Name	Function
1	IN-	Hall input + pin. Hysteresis amplifier
2	IN+	Hall input – pin. Hysteresis amplifier
3	CT	Lockup protection time setting capacitor pin (0.47 to 4.7 μF)
4	ST	Start/stop pin
5	ВС	Output transistor common base pin
6	OUT1	Output 1 pin
9	OUT2	Output 2 pin
7	GND	GND pin
10	Z1	External Zener diode pin (external Zener diode to be connected between power supply and Z1)
11	Z2	Kickback absorption voltage alteration pin (shorted to Z1: 12 V operation)
12	FG	Rotation frequency detector pin
13	RD	Lockup detection pin (latch type)
14	V <sub>IN</sub>	Regulated power supply input pin (limiting resistor to be inserted between power supply and V <sub>IN</sub> )

# **TRUTH TABLE**

ST	IN+	IN-	СТ	OUT1	OUT2	RD	FG
Н	Н	L	L	Н	Н	L	L
	L	Н	L	Н	Н	L	Н
L or OPEN	Н	L	L	Н	L	L	L
	L	Н	L	L	Н	L	Н
	Н	L	Н	Н	Н	Н	L
	L	Н	Н	Н	Н	Н	Н

NOTE: RD is a latch type output.

# **BLOCK DIAGRAM**

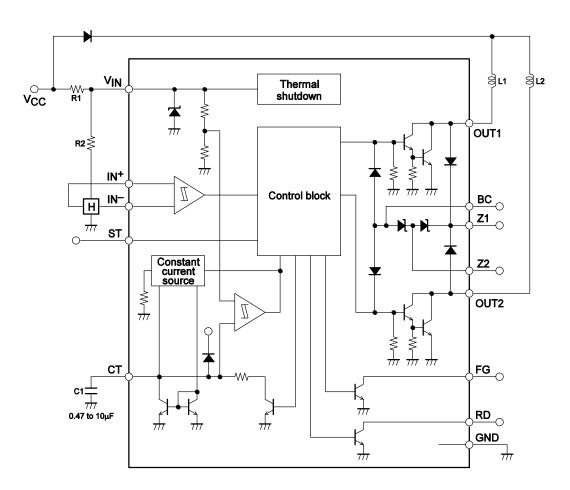


Figure 2. Block Diagram

# **APPLICATION CIRCUIT**

# 1. 12 V Supply Voltage

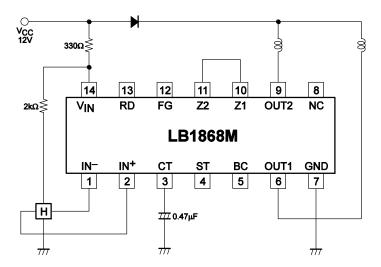


Figure 3. 12 V Supply Voltage

# 2. 24 V Supply Voltage

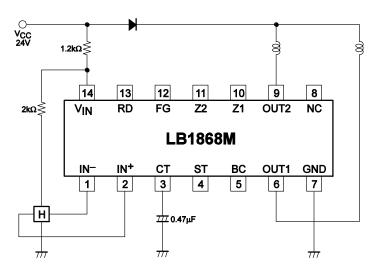


Figure 4. 24 V Supply Voltage

# 3. High-power Fan (120 mm-HH-Speed)

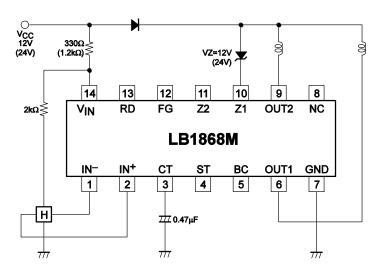
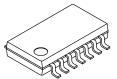


Figure 5. High-power Fan (120 mm-HH-Speed)

## **ORDERING INFORMATION**

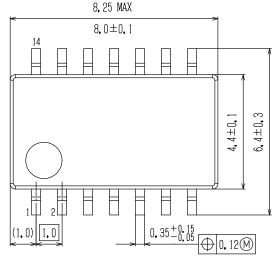
Device	Package	Wire Bond	Shipping <sup>†</sup> (Qty / Packing)
LB1868M-TLM-E	MFP14S (225 mil) (Pb-Free)	Au wire	1,000 / Tape & Reel
LB1868M-TLM-H	MFP14S (225 mil) (Pb-Free / Halogen Free)	Au wire	1,000 / Tape & Reel
LB1868M-W-AH	MFP14S (225 mil) (Pb-Free / Halogen Free)	Cu wire	1,000 / Tape & Reel

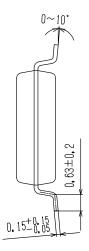
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

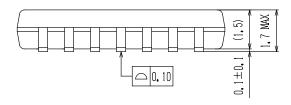


## SOIC14 W / MFP14S (225 mil) CASE 751CB ISSUE A

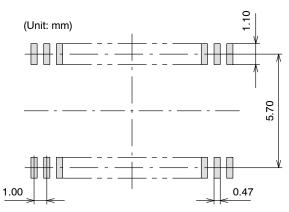
**DATE 25 OCT 2013** 







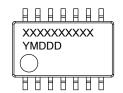
## **SOLDERING FOOTPRINT\***



NOTE: The measurements are not to guarantee but for reference only.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# GENERIC MARKING DIAGRAM\*



XXXXX = Specific Device Code

Y = Year

M = Month

DDD = Additional Traceability Data

\*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " ■", may or may not be present.

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Α	ADDED MARKING AND SOLDER FOOTPRINT INFORMATION. REQ. BY D. TRUHITTE	25 OCT 2013

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